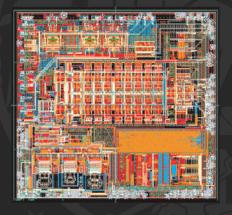
ECE 310 MICROELECTRONICS I

COURSE INTRODUCTION

VISHAL SAXENA VSAXENA@UIDAHO.EDU







COURSE OUTLINE

Instructor : <u>Dr. Vishal Saxena</u>

Office BEL 318

Email: vsaxena AT uidaho DOT edu

Time : MWF, 10:30-11:20 AM

Course dates : Jan 10 – May 4, 2018

Location : EP 205

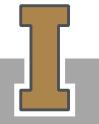
Office Hours : MW 12:00 Noon-1:00 PM (or by appointment)

Website : <u>http://lumerink.com/courses/ECE310/s18/ECE310.htm</u>

O Vishal Saxena

COURSE OBJECTIVES

- This course focuses on design and analysis of microelectronic circuits.
- At the end of the course, it is expected that you will be able to design, analyze and simulate basic microelectronic circuits with confidence.





COURSE TOPICS

- Basics of Semiconductor Physics
- Diode Models and Circuits
- MOS Transistors
- Bipolar Transistors
- MOS and Bipolar Amplifiers and Current Mirrors
- Operational Amplifiers
- Digital CMOS Circuits (if time permits)

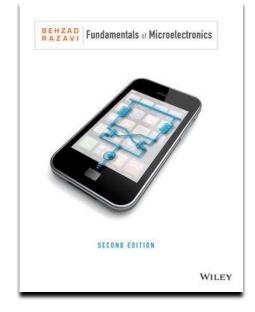


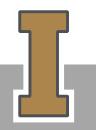
TEXTBOOK

• Fundamentals of Microelectronics -

Behzad Razavi, 2nd Edition, Wiley, 2013. ISBN: 1118156323

- Homeworks will be assigned from the textbook
- Companion Site: <u>http://goo.gl/LQRqOv</u>







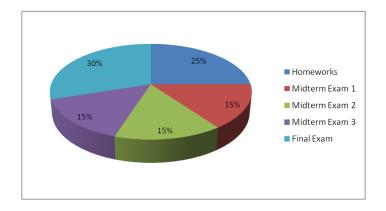
COURSE PEDAGOGY AND GRADING

Combination of lecture notes and slides

- Lecture notes/slides will be posted online at the end of the week
 - Take your own notes in class instead of listening passively

Workload (Grading)

- 25% Homework/In-Class Assignments
- 45% Exams (3) : Check syllabus for tentative exam dates
- 30% Final exam



COURSE POLICIES

- Late work is highly discouraged (see policy on the course page)
- All assigned work is due at the beginning of class on due date
- Final exam will not be returned at the end of the semester
- Avoid internet surfing in class on any device
- Plagiarism and outsourcing (!) of work is not acceptable
 - See UI Student Code of Conduct <u>http://www.webs.uidaho.edu/fsh/2300.html</u>
- Detailed policies are available on the course site





SOME DEFINITIONS

- A semiconductor is a substance that conducts electricity under some but not all circumstances.
- Solid-State Electronics (SSE)
 - Solid-state electronics are those circuits or devices built entirely from solid semiconducting materials and in which the electrons, or other charge carriers, are confined entirely within the solid material





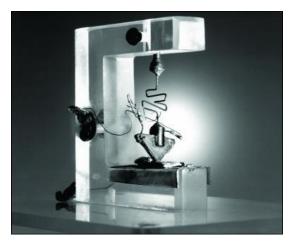
- This distinguishes SSE from devices that use charge carriers not confined with a solid (i.e. plasmas, vacuum).
- The most common SSE are based on pure silicon substrates.



THE START OF THE MODERN ELECTRONICS ERA



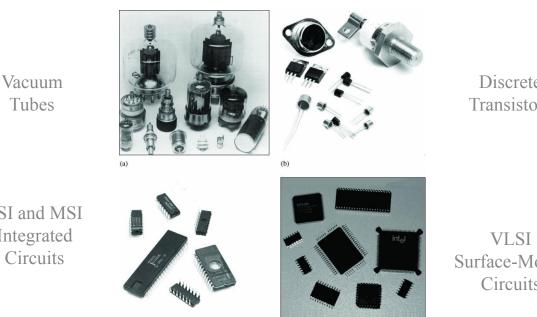
Bardeen, Shockley, and Brattain at Bell Labs - Brattain and Bardeen invented the bipolar transistor in 1947.



The first germanium bipolar transistor. Roughly 50 years later, electronics account for 10% (4 trillion dollars) of the world GDP.



EVOLUTION OF ELECTRONIC DEVICES



(d)

Discrete Transistors

SSI and MSI Integrated Circuits

(c)

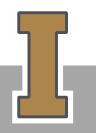
Surface-Mount Circuits

MICROELECTRONICS PROLIFERATION

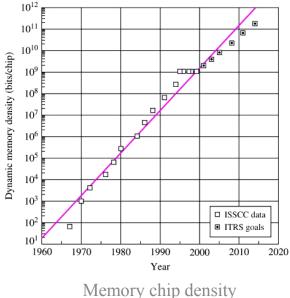
- The integrated circuit was invented in 1958.
- World transistor production has more than doubled every year for the past twenty years.
- Every year, more transistors are produced than in all previous years combined.
- Approximately 10¹⁸ transistors were produced in a recent year.
- Roughly 50 transistors for every ant in the world. *Source: Gordon Moore's Plenary address at the 2003 International Solid State Circuits Conference.

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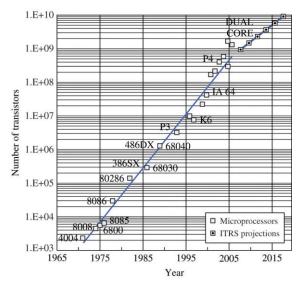
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RAPID INCREASE IN DENSITY OF MICROELECTRONICS



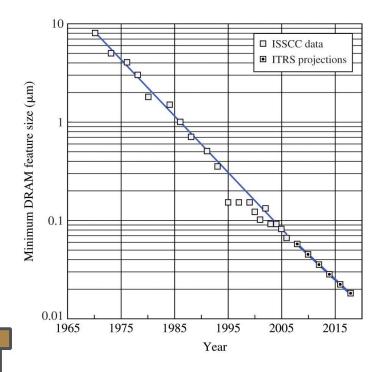
versus time.



Microprocessor complexity versus time.



DEVICE FEATURE SIZE



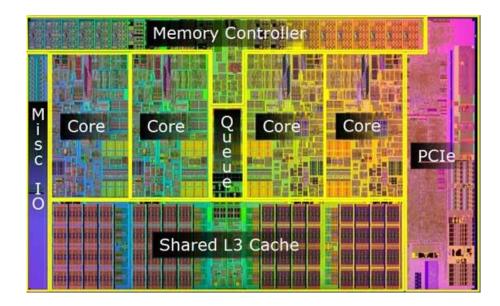
- Feature size reductions enabled by process technology innovations.
- Smaller features lead to more transistors per unit area and therefore higher density.



ECONOMIC IMPACT

- Key driver of global and US economy
 - >\$400B in annual revenue
 - \$166B of US semiconductor industry revenue
 - 20 year annual average growth of 13%
 - Highly innovative field that impacts all other sectors of economy
- Idaho's top export is Semiconductors (Memory Chips) \$2.4B in 2013
- Micron, Intel, Nvidia, Apple, etc. are key players
- Computing and smartphones key consumer products
 - Internet-of-things and AI-based applications to sustain future growth

MICROELECTRONIC ICS IN ACTION



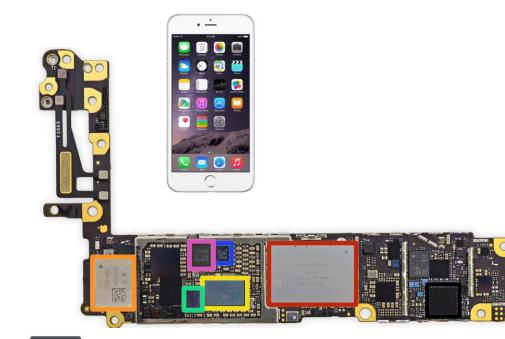
Intel Quad-core Processor (2012)

~1.2 Billion Transistors



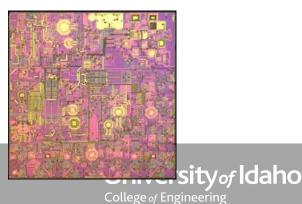


MICROELECTRONIC ICS IN ACTION



https://www.ifixit.com/Teardown/iPhone+6+Teardown/29213

- Back side of the logic board:
 - SanDisk SDMFLBCB2 128 Gb (16 GB) NAND Flash
 - Murata 339S0228 Wi-Fi Module
 - Apple/Dialog 338S1251-AZ Power Management IC
 - Broadcom BCM5976 Touchscreen Controller
 - NXP LPC18B1UK ARM Cortex-M3 Microcontroller (also known as the M8 motion coprocessor)
 - NXP 65V10 NFC module + Secure Element (likely contains an NXP PN544 NFC controller inside)
 - Qualcomm WTR1625L RF Transceiver



ANALOG VS DIGITAL: THE MYTH







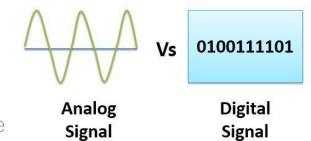




CHARACTERISTICS OF SIGNALS

Analog Signals

- Infinite number of possible signal levels (values)
- Can change at any instant to any other value
 - Bandwidth is potentially infinite
- Analog signals are *continuous* in both time and value
- Digital Signals



- Signal level (value) only representable in fixed steps within a finite range
- Only know the signals value at distinct instants in time
- Digital signals are *discrete* in time and value
- Signal can be exactly identified in the presence of some amount of noise



WHY USE DIGITAL SIGNALS?

Pros

- Digital signals can be faithfully stored and copied
- Allows for numeric processing by digital computers (digital signal processing DSP)
- Lossy and lossless data compression possible
- Can mathematically represent physically unrealizable systems

Cons

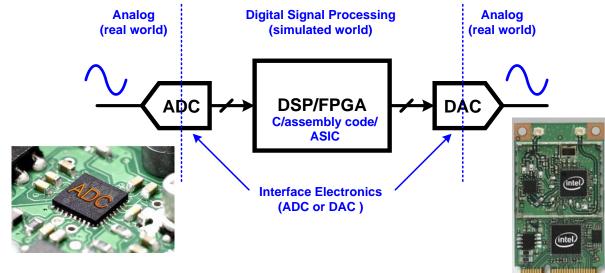
Cannot exactly represent or reconstruct the original analog signal

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Requires greater bandwidth

WHY ANALOG CIRCUITS?



- Real world is analog.
- Digital world: Discrete-time, discrete-amplitude signal representation.
 - Interface circuits: ADC and DACs.
- High speed signal processing circuits are analog (Serial IOs, 60 GHz RF)

YOUR TO-DO LIST

• Read Chapter 1

